



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 09/241,177

Filed: February 1, 1999

For: HIGH DENSITY MODULARITY FOR
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Confirmation No.: 8330

Examiner: C. Novacek

Group Art Unit: 2822

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CERTIFICATE OF MAILING

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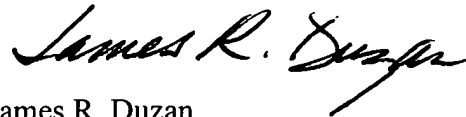
Sir:

This is in response to the Notice of Non-Responsive Amendment of December 17, 2002, which initial period of response is set to expire on January 17, 2003.

Serial No. 09/241,177

The proposed drawing corrections mailed May 13, 2002, and received in the Patent Office on May 28, 2002, have been approved. The formal drawings revised as proposed are submitted concurrently herewith under cover of the Transmittal of Formal Drawings.

Respectfully submitted,



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Date: December 31, 2002
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